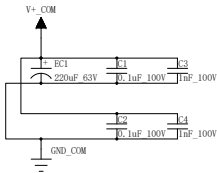
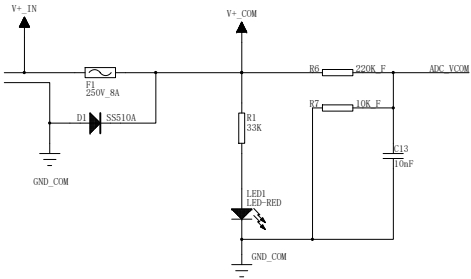


REVISION RECORD			
LTR	ECO NO:	APPROVED:	DATE:

功率电源



一边VM一路

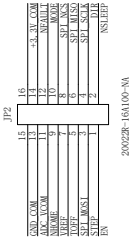
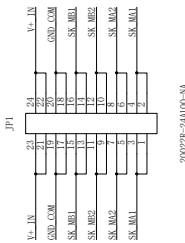
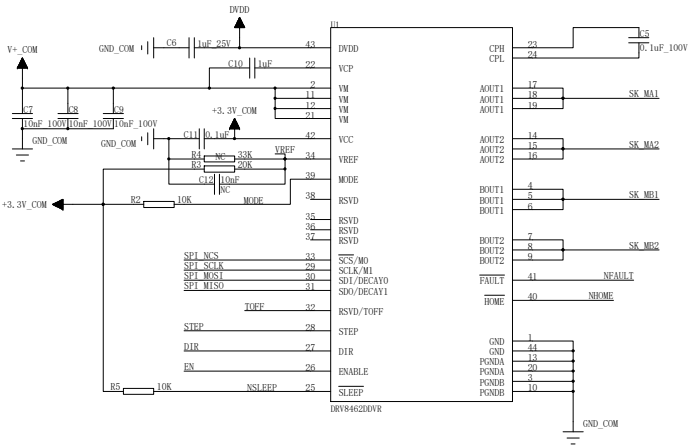
插件电容卧倒焊接，点胶固定

大功率走线

芯片增加大散热片

芯片贴于反面，DDV封装顶部散热

默认内部基准电压，限制在6A
开启省电模式（即锁定自动半流或更低电流）
启用SPI控制方式
开启自动微步功能256
开启静音模式32/32
 $IFS(A) = VREF(V)/KV(V/A)$
 $KV=0.33(DDV封装)$



COMPANY:

TITLE:

DRAWN:	DATED:
CHECKED:	DATED:
QUALITY CONTROL:	DATED:
RELEASED:	DATED:

CODE:	SIZE:	DRAWING NO:	REV:
	C		
SCALE:	SHEET: 1 OF 2		

6

5

4

3

2

1

D

C

B

A

D

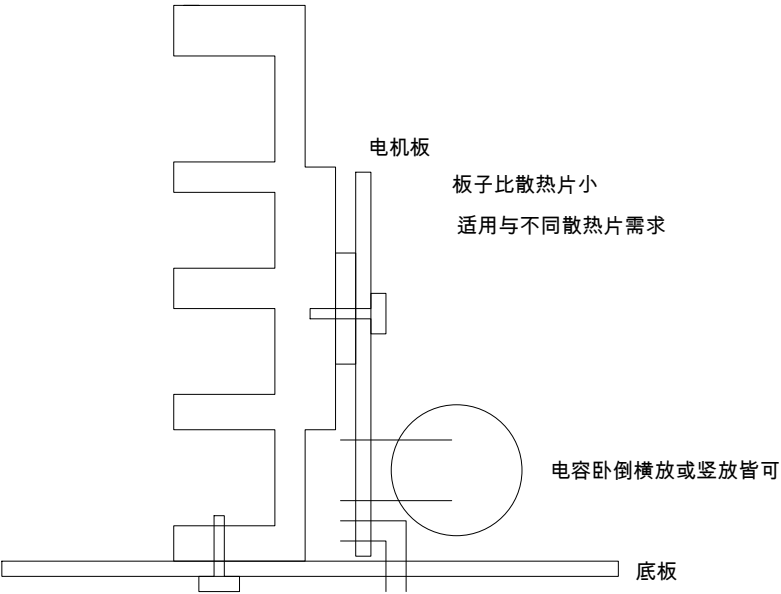
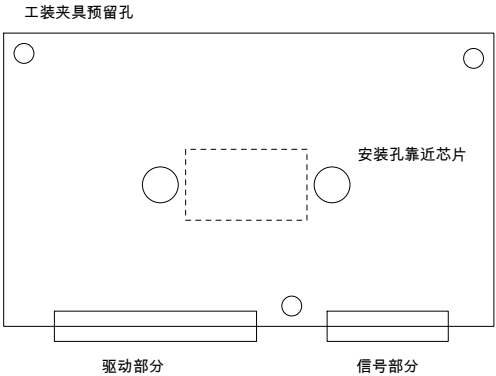
C

B

A

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LTR	ECO NO:	APPROVED:	DATE:

主芯片放反面
散热片安装与反面
测试点放正面



DRAWN:	DATED:
CHECKED:	DATED:
QUALITY CONTROL:	DATED:
RELEASED:	DATED:

COMPANY:			
TITLE:			
CODE:	SIZE: C	DRAWING NO:	REV:
SCALE:		SHEET: 2 OF 2	